

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	9717	capacitor same ("printed circuit board" or pbc)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:09
L4	312	capacitor same ("printed circuit board" or pbc) same embedded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:10
L5	103	capacitor same ("printed circuit board" or pbc) near4 embedded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:10
L6	90	capacitor same ("printed circuit board" or pbc) near3 embedded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:10
L7	72	capacitor same ("printed circuit board" or pbc) near2 embedded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:10
L8	49	(capacitor same ("printed circuit board" or pbc)) near2 embedded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/22 09:10
S1	1688	(257/724).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/21 10:54
S2	1813	(257/686).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/21 12:59

S3	2	("20040183187").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/21 13:08
S4	15860	("integrated circuit" or chip or ic) and (dam or ring) and capacitor and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 13:10
S5	651	("integrated circuit" or chip or ic) and (dam or ring) and capacitor and via and abutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 13:18
S6	13360	("integrated circuit" or "semiconductor chip" or ic) and (dam or ring) and capacitor and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 14:17
S8	3688	("integrated circuit" or "semiconductor chip" or ic) and (metal adj (dam or ring))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 14:19
S9	397	("integrated circuit" or "semiconductor chip" or ic) and (metal adj (dam or ring)) and capacitor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 14:25
S10	29	("integrated circuit" or "semiconductor chip" or ic) and (metal adj dam) and capacitor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/21 14:26